

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2591667

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>JU-LIN HUANG</td> <td>11/23/2011</td> </tr> <tr> <td>KEKO-CHUN LIANG</td> <td>11/23/2011</td> </tr> <tr> <td>PO-YU TSENG</td> <td>11/23/2011</td> </tr> </tbody> </table>		Name	Execution Date	JU-LIN HUANG	11/23/2011	KEKO-CHUN LIANG	11/23/2011	PO-YU TSENG	11/23/2011		
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RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>NOVATEK MICROELECTRONICS CORP.</td> </tr> <tr> <td>Street Address:</td> <td>2F, NO. 13 INNOVATION ROAD I, HSINCHU SCIENCE PARK</td> </tr> <tr> <td>City:</td> <td>HSINCHU</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> <tr> <td>Postal Code:</td> <td>300</td> </tr> </table>		Name:	NOVATEK MICROELECTRONICS CORP.	Street Address:	2F, NO. 13 INNOVATION ROAD I, HSINCHU SCIENCE PARK	City:	HSINCHU	State/Country:	TAIWAN	Postal Code:	300
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PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13312146</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13312146						
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Application Number:	13312146										
CORRESPONDENCE DATA											
<p>Fax Number: (202)408-0924</p> <p>Phone: 202-371-8976</p> <p>Email: firm@rabinberdo.com</p> <p><i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i></p> <p>Correspondent Name: RABIN & BERDO, P.C.</p> <p>Address Line 1: 1101 14TH ST., N.W., SUITE 500</p> <p>Address Line 4: WASHINGTON, DISTRICT OF COLUMBIA 20005</p>											
ATTORNEY DOCKET NUMBER:	SUND-1275										
NAME OF SUBMITTER:	STEVEN M. RABIN										
Signature:	/Steven M. Rabin/										
Date:	10/25/2013										
<p>Total Attachments: 2</p> <p>source=SUND-1275-Assignment#page1.tif</p> <p>source=SUND-1275-Assignment#page2.tif</p>											

OP \$40.00 13312146

ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT

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WHEREAS Ju-Lin Huang, Keko-Chun Liang and Po-Yu Tseng

hereinafter referred to collectively as the assignor, has invented a certain improvement relating to
AMPLIFIER

☒ the inventor's declaration for said application being executed concurrently with the execution of this instrument; said application to be filed in the United States Patent and Trademark Office;

☐ said application having been filed in the United States Patent and Trademark Office on _____, authorization being hereby given to my attorneys, Steven M. Rabin and Robert H. Berdo, Jr. of RABIN & BERDO, P.C., 1101 14th Street, N.W., Suite 500, Washington, D.C. 20005., to insert here in parentheses (Application Serial No. _____) the application serial number of said application when known;

☐ said application having been filed under the Patent Cooperation Treaty on _____, Serial No. _____, the United States of America being designated.

AND WHEREAS NOVATEK MICROELECTRONICS CORP. OF 2F. NO. 13, INNOVATION ROAD I, HSINCHU SCIENCE PARK, HSINCHU 300, TAIWAN, R.O.C., hereinafter referred to as the assignee, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT

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ASSIGNOR:

Signature: Julin HuangPrinted Name: Ju-Lin HuangDate: 2011. 11. 23

ASSIGNOR:

Signature: Po-Yu TsengPrinted Name: Po-Yu TsengDate: 2011. 11. 23.

ASSIGNOR:

Signature: Keko-Chun LiangPrinted Name: Keko-Chun LiangDate: 2011. 11. 23

WITNESS:

Signature: _____

Printed Name: _____

Date: _____